



93/04/015-29



INVESTOR IN PEOPLE

The Patent Office
Concept House
Cardiff Road
Newport
South Wales

NP10 8QQ
REC'D 17 MAY 2004

WIPO PCT

PRIORITY DOCUMENT
SUBMITTED OR TRANSMITTED IN
COMPLIANCE WITH
RULE 17.1(a) OR (b)

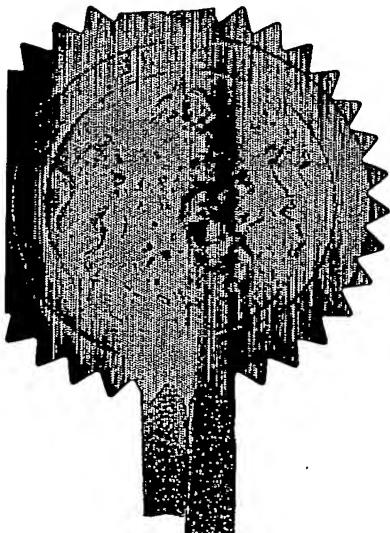
BEST AVAILABLE COPY

I, the undersigned, being an officer duly authorised in accordance with Section 74(1) and (4) of the Deregulation & Contracting Out Act 1994, to sign and issue certificates on behalf of the Comptroller-General, hereby certify that annexed hereto is a true copy of the documents as originally filed in connection with the patent application identified therein.

In accordance with the Patents (Companies Re-registration) Rules 1982, if a company named in this certificate and any accompanying documents has re-registered under the Companies Act 1980 with the same name as that with which it was registered immediately before re-registration save for the substitution as, or inclusion as, the last part of the name of the words "public limited company" or their equivalents in Welsh, references to the name of the company in this certificate and any accompanying documents shall be treated as references to the name with which it is so re-registered.

In accordance with the rules, the words "public limited company" may be replaced by p.l.c., plc, P.L.C. or PLC.

Re-registration under the Companies Act does not constitute a new legal entity but merely subjects the company to certain additional company law rules.



Signed *Mark Gensey*

Dated 30 April 2004

07 APR 2003

RECEIVED BY HAND

The
Patent
Office08APR03 E708402-4 D00054
P01/7700 0700-0308008.2**Request for grant of a patent***(See the notes on the back of this form. You can also get an explanatory leaflet from the Patent Office to help you fill in this form)*

The Patent Office

Cardiff Road
Newport
South Wales
NP9 1RH

1. Your reference P34099EP/NJH

2. Patent application number
*(The Patent Office will fill in this part)*3. Full name, address and postcode of the or of each applicant *(underline all surnames)*Patents ADP number *(if you know it)*

If the applicant is a corporate body, give the country/state of its incorporation.

0308008.2

7 APR 2003

Zellweger Analytics Ltd.
Hatch Pond House
4 Stinsford Road
Nuffield Estate
Poole, Dorset BH17 0RZ

United Kingdom

6988349001

4. Title of the invention

METHOD OF MANUFACTURING GAS DIFFUSION ELECTRODES

5. Name of your agent *(if you have one)*"Address for service" in the United Kingdom to which all correspondence should be sent *(including the postcode)*Kilburn & Strode
20 Red Lion Street
London
WC1R 4PJPatents ADP number *(if you know it)*

125001

6. If you are declaring priority from one or more earlier patent applications, give the country and the date of filing of the or of each of these earlier applications and *(if you know it)* the or each application number

Country

Priority application number
*(if you know it)*Date of filing
(day / month / year)

7. If this application is divided or otherwise derived from an earlier UK application, give the number and the filing date of the earlier application

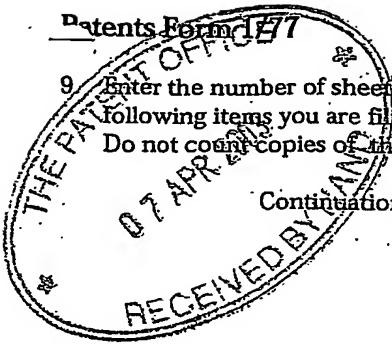
Number of earlier application

Date of filing
*(day / month / year)*8. Is a statement of inventorship and of right to grant of a patent required in support of this request? *(Answer 'Yes' if:*

- a) *any applicant named in part 3 is not an inventor, or*
- b) *there is an inventor who is not named as an applicant, or*
- c) *any named applicant is a corporate body.*

See note (d))

YES



9. Enter the number of sheets for any of the following items you are filing with this form. Do not count copies of the same document

Continuation sheets of this form

| | |
|-------------|-------------|
| Description | 10 |
| Claim(s) | 2 |
| Abstract | 0 |
| Drawing(s) | 1 <i>45</i> |

10. If you are also filing any of the following, state how many against each item.

| | |
|--|---|
| Priority documents | 0 |
| Translations of priority documents | 0 |
| Statement of inventorship and right to grant of a patent (Patents Form 7/77) | 0 |
| Request for preliminary examination and search (Patents Form 9/77) | 1 |
| Request for substantive examination (Patents Form 10/77) | 0 |
| Any other documents (please specify) | 0 |

11.

I/We request the grant of a patent on the basis of this application.

Signature

Date 7 April 2003

12. Name and daytime telephone number of person to contact in the United Kingdom

N J M Hedley
Tel: 020 7539 4200

Warning

After an application for a patent has been filed, the Comptroller of the Patent Office will consider whether publication or communication of the invention should be prohibited or restricted under Section 22 of the Patents Act 1977. You will be informed if it is necessary to prohibit or restrict your invention in this way. Furthermore, if you live in the United Kingdom, Section 23 of the Patents Act 1977 stops you from applying for a patent abroad without first getting written permission from the Patent Office unless an application has been filed at least 6 weeks beforehand in the United Kingdom for a patent for the same invention and either no direction prohibiting publication or communication has been given, or any such direction has been revoked.

Notes

- a) If you need help to fill in this form or you have any questions, please contact the Patent Office on 0645 500505.
- b) Write your answers in capital letters using black ink or you may type them.
- c) If there is not enough space for all the relevant details on any part of this form, please continue on a separate sheet of paper and write "see continuation sheet" in the relevant part(s). Any continuation sheet should be attached to this form.
- d) If you have answered 'Yes' Patents Form 7/77 will need to be filed.
- e) Once you have filled in the form you must remember to sign and date it.
- f) For details of the fee and ways to pay please contact the Patent Office.

DUPLICATE

Method of Manufacturing Gas Diffusion Electrodes

Field of the Invention

The present invention relates to a method of manufacturing gas diffusion electrodes, for use, for example, in gas sensors or fuel cells or other applications where gas diffusion electrodes are utilised.

Background of the Invention

Gas diffusion electrodes are well known and consist of a hydrophobic substrate layer, usually of PTFE, on one surface of which there is deposited a catalytic layer of controlled wettability. The side of the hydrophobic substrate containing the catalyst is placed in contact with an aqueous electrolyte; the other side is in contact with a gas. Gas, e.g. oxygen, can diffuse through the porous PTFE sheet and come into a contact with the catalyst wetted with electrolyte, where it can react electrochemically. Current from the reaction can be drawn from the electrode using a current collector.

Gas diffusion electrodes are made by several routes:

- 1) A slurry containing catalyst powder and small PTFE particles is dispensed into a well formed in a sacrificial medium, e.g. a foil. The use of a well allows the slurry to contain a high proportion of suspending liquid, e.g. water, which improves the accuracy of the amount of catalyst dispensed and also reduces the tendency of the catalyst to coagulate. A surfactant may be included in the slurry to reduce the tendency of the catalyst to coagulate. The dispensed slurry in the cavity is then dried by driving off the water (or other low boiling point carrier solvent) via low temperature oven cycles. The dried electrode is then cured at high temperatures to decompose organic stabilisers and thickeners, e.g. surfactants and polymers. If heated too quickly, the surfactants can combust, causing a sharp increase in temperature, which damages the electrode and can render it useless. Accordingly, tightly controlled heating rates are critical to the production of consistent electrodes. Once all the organic stabilisers have been decomposed, the catalyst is transferred to a PTFE

5 tape by laying the tape across the top of the cavity containing the catalyst and the tape and the foil carrier are lightly pressed together between two flat surfaces and then transported to a press where they are subjected to a large pressure for a controlled amount of time. The foil is then peeled away, leaving the catalyst on the PTFE.

10 A disadvantage of the above process is that the controlled temperature regime required makes this process long drawn out and therefore expensive. Also, the transfer of the catalyst from the foil to the PTFE tape is often imperfect with some of the catalyst sticking to the foil. Additionally, the foil material can poison the catalyst, possibly alloying with the catalyst metal or leaving metal residues which may affect the catalyst activity.

15 2) Gas diffusion electrodes can be produced by screen printing a catalyst-containing ink onto a PTFE sheet. The rheology of the ink is critical. Unfortunately, because the ink is exposed to air during the screen printing process, it can dry out, which changes the rheology of the ink. Furthermore, the ink will contain substantial quantities of organic surfactants which must be decomposed by complex thermal treatment. If the temperature of the thermal 20 treatment is too high, the surfactants will combust and the heat given out by the combustion will damage the electrode by localised thermal sintering/ melting/processing of the porous PTFE substrate. If the organic surfactants are left in, this will compromise the performance of the electrode by reducing the hydrophobicity of the substrate.

25

After screen printing, the deposit is pressed to form the final electrode.

30 3) The catalyst can be spray deposited onto a substrate through a mask. The substrate can be a sacrificial substrate. The required catalyst area is punched out from the sprayed substrate and the catalyst is transferred to a PTFE substrate using pressure as described in method 1) above. The disadvantages

of this method are similar to those described above in connection with method 1).

4) The catalyst can be directly sprayed onto a sacrificial carrier, using a mask to 5 create the desired electrode shape, and the catalyst deposit subsequently transferred to the PTFE substrate. This process has the same disadvantage and advantages as catalyst transfer mentioned in method 1) above and many of the disadvantages of screen printing in method 2); it has the additional drawback of providing lower catalyst utilisation because a high percentage of the 10 catalyst-containing liquid is deposited onto the mask.

It will be appreciated that the accurate deposition of a precise dose of catalyst is 15 essential to the manufacture of these gas electrodes since the catalyst is generally expensive (e.g. platinum) and since the amount of catalyst affects the performance of the electrode in that a catalyst loading that varies from electrode to electrode can give 20 rise to different outputs, which is problematic when the electrodes are used for quantitative measurement, e.g. in gas sensors.

The present invention provides a process that provides consistent electrodes with low 25 wastage of expensive catalyst and that is readily subject to mechanisation.

Summary of the Invention

According to the present invention, there is provided a process for manufacturing a 25 gas diffusion electrodes, which process comprises:

1) forming a well in a pre-shrunk porous hydrophobic substrate,
2) surface treating the hydrophobic substrate to render the substrate that is 30 in the well or is destined to be within the well less hydrophobic,
3) dispensing a slurry of catalyst into the surface treated well,
4) removing the liquid from the dispensed slurry,
5) treating the dried slurry to remove organic materials, and

- 6) cutting the substrate and the catalyst deposit to form an electrode comprising a porous and conductive catalyst mass supported on the substrate.
- 5 Step 2) can be performed before step 1), in which case, the surface treatment takes place in those places in which the well will be formed.

As used herein the term "slurry" is intended to denote catalyst suspended in an aqueous liquid and is not intended to imply anything about the tendency of the catalyst to settle out, although it is preferred that the catalyst will remain in suspension under moderate stirring and with the addition of water-soluble thickeners, e.g. modified cellulose-based polymers, which increase the viscosity of the slurry and slow the rate of catalyst sedimentation.

- 10 15 Preferably, the hydrophobic substrate is heat treated before the well is formed in order to remove inherent stresses in the substrate so that it will not deform during subsequent heat treatment during the manufacturing process. This pre-treatment should take place at a temperature equal to or greater than that experienced during the subsequent manufacturing process and is typically between 280 to 310°C. During the 20 heat pre-treatment, the substrate should not be constrained by its sides in any way but should merely be supported by a flat surface. After pre-treatment, internal stresses within the substrate have been removed and thus, when reheated during the subsequent process, the substrate is thermally stable and stays flat.
- 25 30 The well in the hydrophobic layer can be formed by a simple pressing operation, although care should be taken not to induce excessive stress in the hydrophobic layer during the pressing process. The well can be formed by placing a pre-shrunk hydrophobic PTFE substrate over a support/former, made for example, of inert metal and having a recess. The substrate can then be pressed into the recess to form the well using an embossing head covered with resilient material, e.g. rubber or foam. The support/former may then be used to support the hydrophobic substrate during subsequent process steps, which has the advantage that, during heat treatment, it

provides shielding against thermal shock and also provides a thermal sink to remove heat if the temperature at parts of the electrode rise excessively.

5 The surface modification step 2) reduces the hydrophobicity of the substrate in the areas where the catalyst slurry is to be deposited. This allows the aqueous slurry to form a coherent deposit without beading up excessively. If only the area within the well is surface treated, then the hydrophobic nature of the substrate outside the treated area will help prevent the slurry from flowing over it and so will help retain the slurry in the treated area, thereby confining the slurry to the well. This confinement is 10 especially beneficial during transport of the well and slurry, e.g. to an oven, since the slurry will have a reduced tendency to spill over the edges of the well when jerked, because of the more hydrophobic nature of the substrate outside the well. A further significant advantage of surface treatment is a lowering of the requirement for surfactant within the slurry.

15 Any process that increases the surface energy of the hydrophobic layer is acceptable. Preferred surface treatments include corona discharge treatment, plasma discharge treatment. Although surface treatment could be achieved by deposition of a surfactant onto the surface, this is not preferred since it increases the organic content of the 20 electrode, which must be removed during a subsequent heat curing process, which must be tightly controlled to prevent the exothermic combustion of the surfactant that could damage the electrode.

25 In step 3), the slurry is dispensed onto the surface treated substrate within the well using any suitable means. We prefer to dispense the slurry through a nozzle, feeding the slurry from a sealed reservoir; the use of a sealed reservoir prevents the slurry drying out during the process. The slurry may be stirred inside the reservoir to maintain a uniform catalyst distribution within the slurry.

30 The viscosity of the liquid in the slurry should not be too low or else the catalyst will readily settle out in the reservoir and it will be difficult to achieve consistent doses of

catalyst. On the other hand, the viscosity of the slurry should not be too high or else the deposited slurry will not coalesce into a coherent pool within the well.

After the slurry has been dispensed, the well containing the slurry is treated (step 4)) to remove the liquid of the slurry, generally by evaporation, and finally is heat treated in order to remove organic materials within the slurry. As mentioned above, because the hydrophobic substrate has already been heat treated before the slurry is deposited (step 2)), the heat treatments to remove liquid and organic material do not shrink the substrate further. The surface treatment reduces the amount of organic material required for the slurry and so simplifies and shortens the heating stage and also reduces the risk of damage to the electrode due to combustion of the organic materials.

Finally, the catalyst deposit is cut out from the rest of the hydrophobic substrate to provide the electrode. However, it will generally be necessary to press the cut-out electrode in order to improve mechanical adhesion between the catalyst deposit and the PTFE substrate (described as "keying in" of the catalyst). In addition, the pressing will have the effect of flattening the electrode, which makes subsequent processing operations simpler.

The hydrophobic substrate is preferably PTFE.

The catalyst slurry preferably contains a surfactant, e.g. a water-soluble non-ionic surfactant, that will retain the catalyst in the suspension and will burn off well during subsequent heat treatment. Thus, Triton X is preferred; but other surfactants may also be used.

Brief description of the Drawing

A process according to the invention will now be described, by way of example only, by reference to the accompanying schematic drawing of the process.

Description of the Preferred Method of putting the Invention into Effect

A microporous hydrophobic PTFE sheet 10 is heat treated – see step (a) depicted in the accompanying drawing - by laying it on a flat surface and exposing it in an oven to a temperature between 280 to 310°C so as to provide uniform heating of the PTFE layer for sufficient time to allow the PTFE to shrink uniformly. The oven temperature is chosen to be higher than the temperatures that the PTFE layer will be exposed to in any subsequent manufacturing procedures or in use to ensure that no further shrinkage in the PTFE sheet 10 occurs. Generally, this shrinkage stage will take place in about 30 minutes following the PTFE attaining the oven temperature.

10

Although the PTFE layer will generally be microporous, some gas electrodes react with dissolved gases and accordingly the PTFE substrate need not, in those circumstances, be microporous. However, it is generally convenient to use microporous PTFE substrates even when acting on dissolved gases to avoid having to make separate porous and non-porous electrodes.

15

The PTFE substrate can be obtained from W.L. Gore and Associates (UK) Ltd Kirkton South Road, Kirkton Campus, Livingston, West Lothian EH54 7BT and will have a thickness appropriate for the application of the electrode.

20

If the PTFE layer is placed on a flat surface during the above pre-shrinkage procedure, it will generally retain its flat shape and it will not be necessary to flatten it.

25

The pre-shrunk PTFE layer 10 is then placed over a female former 11 (see step (b) of the drawing) that includes a cavity 12 of approximately the same volume as the volume of catalyst slurry that it is intended to dispense in a subsequent step (see below). A rubber or foam head 14 is then brought down on the sheet 10 to urge it into the cavity 12 to form a well 16 in the PTFE sheet 10.

30

In step (c), a mask 18 is placed over the rim of the well 16 and the area of the sheet 10 within the well 16 is treated by a plasma or corona discharge head to modify the

surface of the PTFE sheet within the well (as shown schematically by dotted lines in step (c)). The precise conditions of the surface treatment will depend on the nature of the PTFE layer but the treatment should be such as to increase the surface energy by at least 10 to 15 dynes/cm², e.g. from less than 20 dynes/cm² to greater than 34 dynes/cm².

Because of the use of the mask 18, the surface treatment only extends as far as the rim of the well and accordingly the material above the rim is not surface treated and so is more hydrophobic than the PTFE sheet within the well.

10

In step (d), an aqueous slurry of catalyst 19 is dispensed from a closed container (not shown) equipped with a stirrer. The slurry will generally contain approximately 10 to 25% by weight of the catalyst, but the catalyst loading can generally be varied over a wide range, according to other process variables. The catalyst may be, for example, platinum having a typical mean particle diameter distribution of 6 to 12 µm, as measured by a Malvern light-scattering analysis on an aqueous suspension of catalyst powder. Different catalyst particle sizes can be used to optimise the electrode performance, although an upper limit is imposed on the size of the catalyst particles by the need to keep the particles in suspension prior to being dispensed into a well; suspension can be achieved to a certain extent stirring, by adjusting the viscosity of the slurry, i.e. adding more thickener, and by adding a surfactant. 90 % of the catalyst particles should will generally have a particle diameter of < 32µm.. The preferred surfactant is Triton X and the preferred thickeners are modified cellulose polymers, e.g. methyl, ethyl, propyl and hydroxypropyl methyl cellulose compounds. Typically the slurry will contain <1% w/w of thickeners. The amount of surfactants and thickeners should be kept to the minimum amount feasible to keep the slurry catalyst in suspension under the conditions prevailing in the slurry reservoir since they need to be removed, by heat treatment, after the deposition of the slurry into the well (see below).

20

30 The deposition of the slurry (step (d)) can take place using any suitable technique, for example via a syringe 20 (as shown) or by spraying, printing or writing techniques.

5 The slurry is aqueous but will not bead-up within the well as a result of the surface treatment in step (c) above and the inclusion of the small amount of surfactant in the slurry; the slurry will thus wet the walls of the well. However, because the PTFE sheet 10 outside the well has not been surface treated, the slurry will not readily flow out of the well, e.g. if jolted during transport of the slurry-filled wells.

10 The PTFE sheet 10 with its slurry-filled well is then transported to an oven where it is heat treated firstly to evaporate the water and then, at a higher curing temperature, to decompose organic materials (thickeners and surfactants) within the slurry. A typical temperature would be as follows:

Drying: 80-85°C for ten minutes to drive off approximately 35 µl of water per well.

15 Curing: Ramp from 80°C to 290°C at 5 °Cmin⁻¹ and hold at 290°C for eighty minutes. This is significantly shorter than previous curing processes for slurries, which contain higher surfactant concentrations.

20 The well 16, after heat treatment, is shown at (e) in the accompanying drawing and during step (e), a ring stamp 22 to stamp out an electrode 24 shown at (f). The electrode is then removed from the cavity 12 and lightly pressed (step (g)) in order to improve mechanical adhesion between the catalyst deposit and the PTFE substrate. The pressing also flattens the electrode, which makes subsequent processing operations simpler. A typical press would use machined steel pressing plates with a surface layer approximately 5 mm thick of 70-90 Shore hardness rubber to apply a 25 force of approximately 600-900 N per 17 mm diameter electrode press head.

30 The advantage of the process of the present invention lies in the combination of the direct deposition of the catalyst onto the electrode substrate and the surface treatment of the substrate, which reduces the requirement for the surfactant to form a uniform catalyst deposit on the hydrophobic substrate. Because less surfactant is used, its removal is easier. In addition, because the surface onto which the catalyst is deposited is more hydrophilic/less hydrophobic than the surrounding area, the catalyst

deposited tends to be retained within the treated area and the use of a well assists in this regard. The retention of the catalyst deposit within a predefined area allows the substrate to be moved with the catalyst slurry during manufacture without spillage, which would affect the shape of the final electrode, and so allows ready automation of the process. The direct deposition of the catalyst onto the substrate of the electrode without the use of intermediate transfer sheets also simplifies production.

CLAIMS

1. A process for manufacturing a gas diffusion electrodes, which process comprises:

- 5 1) forming a well in a pre-shrunk porous hydrophobic substrate,
- 2) surface treating the hydrophobic substrate to render the substrate that is in the well or is destined to be within the well less hydrophobic,
- 3) dispensing a slurry of catalyst into the surface treated well,
- 4) removing the liquid from the dispensed slurry,
- 10 5) treating the dried slurry to remove organic materials, and
- 6) cutting the substrate and the catalyst deposit to form an electrode comprising a porous and conductive catalyst mass supported on the substrate.

2. A process as claimed in claim 1, wherein step 2) is performed after step 1) or
15 *vice versa*.

3. A process as claimed in claim 1 or claim 2, wherein step 4) comprises heating the slurry to evaporate the liquid.

4.

20 4. A process as claimed in any one of claims 1 to 3, wherein step 5) comprises heating the dried slurry to a temperature sufficient to decompose the organic materials.

5. A process as claimed in claim 4 or claim 5, which includes pre-shrinking the
25 hydrophobic substrate by heat treatment at a temperature greater than that used in either of steps 4) or 5).

6. A process as claimed in any one of claims 1 to 5, wherein the surface modification step reduces the hydrophobicity of the substrate only in the area of the
30 substrate within a well or that are destined to form a well.

7. A process as claimed in any one of claims 1 to 6, which includes a further step in which:

the catalyst deposit is cut out from the rest of the hydrophobic substrate to provide the electrode

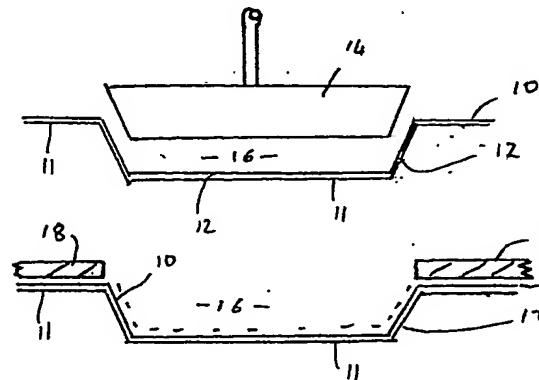
5

6. A process as claimed in any one of claims 1 to 5, wherein the hydrophobic substrate is PTFE.

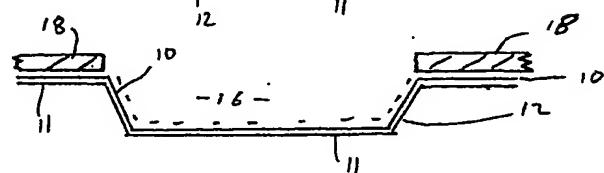
(a)



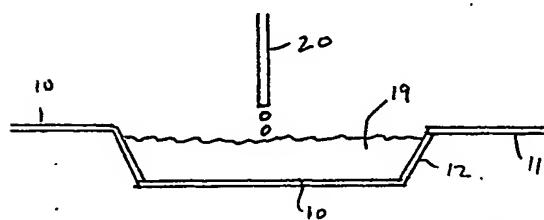
(b)



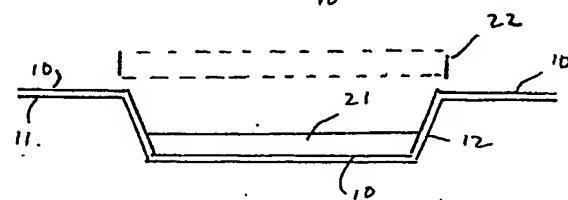
(c)



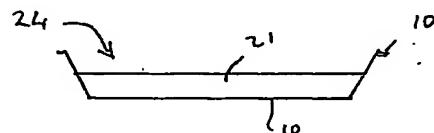
(d)



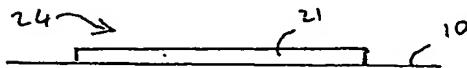
(e)



(f)



(g)



This Page is inserted by IFW Indexing and Scanning
Operations and is not part of the Official Record

BEST AVAILABLE IMAGES

Defective images within this document are accurate representations of the original documents submitted by the applicant.

Defects in the images include but are not limited to the items checked:

- BLACK BORDERS
- IMAGE CUT OFF AT TOP, BOTTOM OR SIDES
- FADED TEXT OR DRAWING
- BLURED OR ILLEGIBLE TEXT OR DRAWING
- SKEWED/SLANTED IMAGES
- COLORED OR BLACK AND WHITE PHOTOGRAPHS
- GRAY SCALE DOCUMENTS
- LINES OR MARKS ON ORIGINAL DOCUMENT
- REPERENCE(S) OR EXHIBIT(S) SUBMITTED ARE POOR QUALITY
- OTHER: _____

IMAGES ARE BEST AVAILABLE COPY.
As rescanning documents *will not* correct images
problems checked, please do not report the
problems to the IFW Image Problem Mailbox